

MOS FIELD EFFECT TRANSISTOR **2SK3109**

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3109 is N channel MOS FET device that features a low on-state resistance and excellent switching characteristics, and designed for high voltage applications such as DC/DC converter.

ORDERING INFORMATION

PART NUMBER	PACKAGE		
2SK3109	TO-220AB		
2SK3109-S	TO-262		
2SK3109-ZJ	TO-263		

FEATURES

- Gate voltage rating ±30 V
- · Low on-state resistance

 $R_{DS(on)} = 0.4 \Omega MAX. (V_{GS} = 10 V, I_{D} = 5.0 A)$

· Low input capacitance

Ciss = 400 pF TYP. (VDS = 10 V, VGS = 0 V)

- · Avalanche capability rated
- · Built-in gate protection diode
- · Surface mount device available

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to source voltage (Vgs = 0 V)	VDSS	200	V
Gate to source voltage (Vps = 0 V)	Vgss	±30	V
Drain current (DC) (Tc = 25 °C)	I _{D(DC)}	±10	Α
Drain current (pulse) Note1	ID(pulse)	±30	Α
Total power dissipation (T _A = 25 °C)	P _{T1}	1.5	W
Total power dissipation (Tc = 25 °C)	P _{T2}	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C
Single avalanche current Note2	las	10	Α
Single avalanche energy Note2	Eas	35	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

2. Starting T_{ch} = 25 °C, V_{DD} = 100 V, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0 V

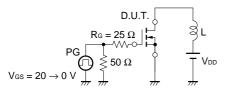
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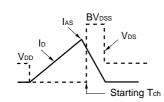
Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

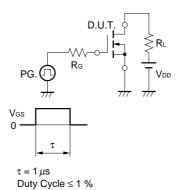
	Characteristics	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
	Drain Leakage Current	IDSS	V _{DS} = 200 V, V _{GS} = 0 V			100	μΑ
	Gate Leakage Current	Igss	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ
	Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	2.5		4.5	V
	Forward Transfer Admittance	yfs	VDS = 10 V, ID = 5.0 A	1.5			S
	Drain to Source On-state Resistance	RDS(on)	Vgs = 10 V, ID = 5.0 A		0.32	0.4	Ω
	Input Capacitance	Ciss	V _{DS} = 10 V		400		pF
	Output Capacitance	Coss	V _G s = 0 V		110		pF
	Reverse Transfer Capacitance	Crss	f = 1 MHz		55		pF
	Turn-on Delay Time	td(on)	V _{DD} = 100 V		12		ns
	Rise Time	tr	ID = 5.0 A		34		ns
	Turn-off Delay Time	td(off)	V _{GS(on)} = 10 V		40		ns
	Fall Time	t f	$R_G = 10 \Omega$		20		ns
*	Total Gate Charge	Q _G	V _{DD} = 160 V		18		nC
	Gate to Source Charge	Qgs	Vgs = 10 V		3.5		nC
	Gate to Drain Charge	Q _{GD}	I _D = 10 A		10		nC
	Diode Forward Voltage	V _{F(S-D)}	I _F = 10 A, V _{GS} = 0 V		1.0		V
	Reverse Recovery Time	trr	IF = 10 A, VGS = 0 V		250		ns
	Reverse Recovery Charge	Qrr	di/dt = 50 A/μs		1.0		μC

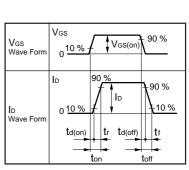
TEST CIRCUIT 1 AVALANCHE CAPABILITY



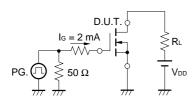


TEST CIRCUIT 2 SWITCHING TIME

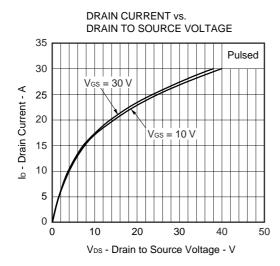


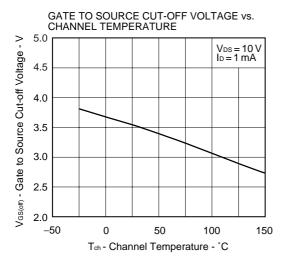


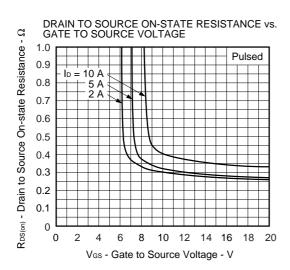
TEST CIRCUIT 3 GATE CHARGE

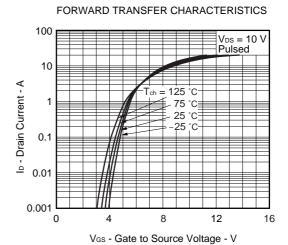


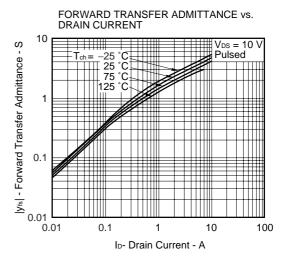
★ TYPICAL CHARACTERISTICS (TA = 25 °C)

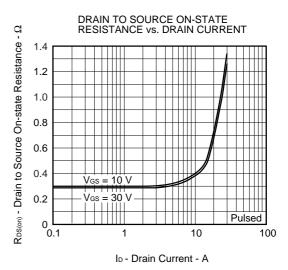






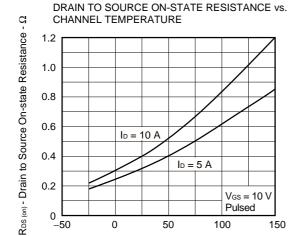




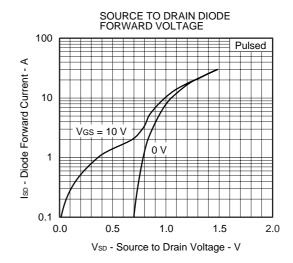


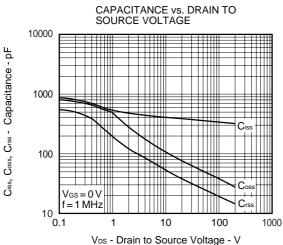
0

-50



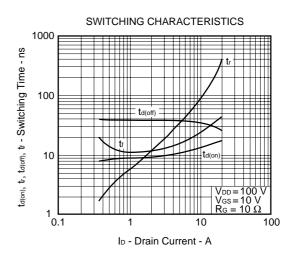


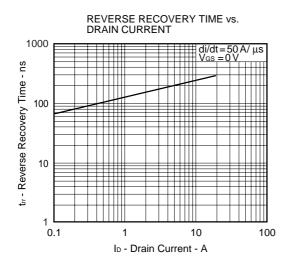


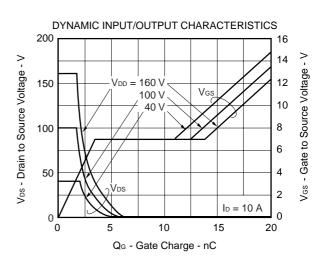


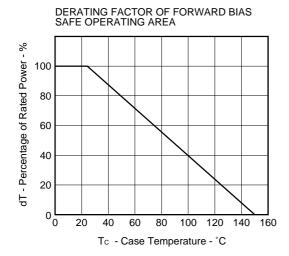
Pulsed

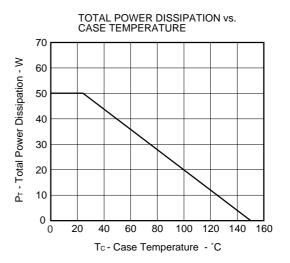
150



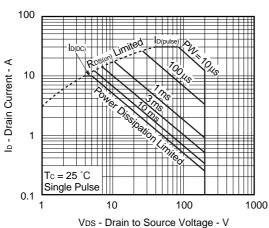




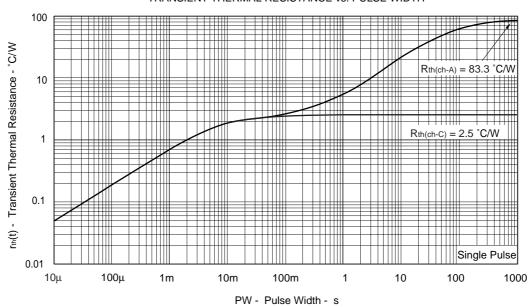




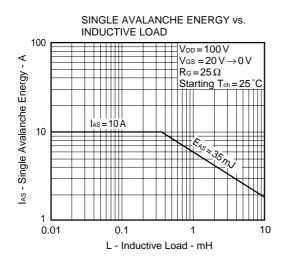
FORWARD BIAS SAFE OPERATING AREA



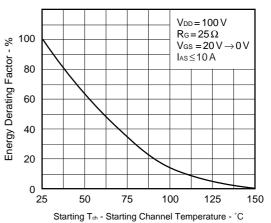
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



5

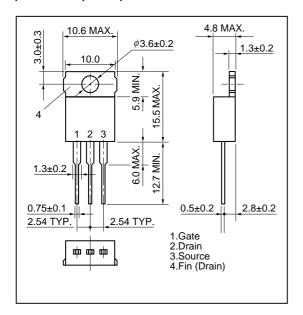


SINGLE AVALANCHE ENERGY DERATING FACTOR

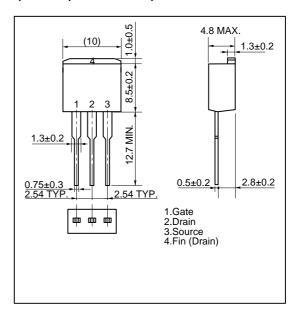


PACKAGE DRAWINGS (Unit:mm)

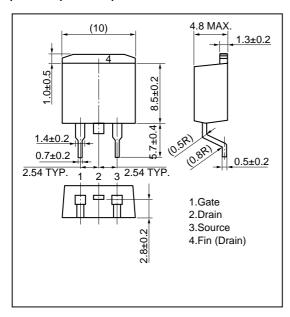
1)TO-220AB (MP-25)



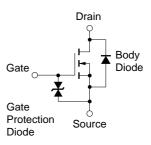
2)TO-262 (MP-25 Fin Cut)



3)TO-263 (MP-25ZJ)



EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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 - Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
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